

Versatile, Flexible AC/DC Test System

Everyone wants to reduce the cost of test. *HILEVEL* has gone a step beyond, by defining the *future* of test with the Griffin III Hybrid system. We call it "Hybrid" simply because it combines the most versatile offerings of features in a single system, at the lowest cost. For devices requiring DC and Continuity test capability only, G3H is a very flexible cost-effective Production Test solution. This approach provides a DC test system with the capability to add logic resources (AC/SCAN) as well as analog resources for Mixed Signal. The *HILEVEL* Griffin III Hybrid embraces low cost while supporting SCAN, giving you the ability to toggle every node in your chip. Contact *HILEVEL* today, and start getting serious "mileage" from your tester.





AC/DC Test







Price and Performance

The flexibility of a *HILEVEL* system brings new price/performance efficiency to the Tester-in-a-Head tradition, a concept created and introduced by *HILEVEL* in 1987. This tester is a superior cost-effective solution for Mass Production applications. *HILEVEL*'s own proprietary tester ASICs provide the power and versatility so crucial in a Production Test system.

Multi-Site

Each DC PEB card provides DC test for 128 pins. The *HILEVEL* G3H chassis has slots for 8 DC boards (Up to 32 sites of 32 DC pins each) and four slots for standard PEB pin electronics boards for full AC, DC or SCAN testing (32 pins each). This standard configuration of the *HILEVEL* Griffin III Hybrid DC system can support up to 1,024 DC pins plus 128 AC/DC channels, but other configurations are available. Software assigns the desired number of sites among these boards; all pins in one site, or divide the pins into two sites, four sites, etc. The G3H system can provide up to 40 power supplies for Multi-site testing.





Rich in GUI functions for engineering, and all the capabilities that make a mass production tester fast, HILEVEL's new Symphony III software provides the tools for efficient test development.



Analog Resources for Mixed-Signal Testing

HiLevel's Mixed Signal resource is more flexible than ever with the MX2. The modular design allows you to configure the MX2 with the analog resources that best fit your application. Choose from 16-bit or 24-bit AWGs, and 16-bit and 24-bit digitizers.





Direct Docking

The Compact G3H and low-cost manipulator make a great team for direct docking. Used with our precision J750-compatible pogo tower, HiLevel's Griffin III Hybrid can easily adapt to your direct docking test needs.







MAINFRAME	OTHER SLOTS
Maximum DC Pins (8 slots)	Optional Power Supplies (2 slots)
Up to 1,024 DC pins in increments	Accommodates one or two MPS optional
of 128 pins (128 pins per slot).	DUT Power Supply boards.
Maximum sites: 32	
	MX2 Mixed Signal Option (2 slots)
Maximum AC Pins (4 slots)	Install one or two configurable MX2
Up to 128 AC pins in increments	boards for Analog resources.
of 32 pins (32 pins per slot).	
Maximum AC sites: 4	FCB Fast Clock Board Option (1 slot)
Other configurations are available.	System Basic Boards (3 slots)







DC PIN RESOURCES DC Drive Range: 0-5V Resolution: 20mV Current: Sink/Source ±10mA	All measurements referenced to DUT ground.
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DC PARAMETRIC MEASUREMENTS

One DCPMU per 32 pins (4 per DC card) Force Voltage Range: -8V to +8V Resolution: 1mV

Voltage Measurement Range: -8V to +8V Accuracy: $0.2\% \pm 2mV$

Force Current Range: -150 mA to +150 mA Resolution & Accuracy: Range Dependent

Current Measurement Range: ± 150 mA Resolution & Accuracy: Range Dependent

Current Ranges	Resolution	Accuracy
± 200 nA	10 pA	$\pm 0.4\%$ of Value + 40 pA
$\pm 2 \ \mu A$	100 pA	$\pm 0.3\%$ of Value + 400 pA
$\pm 20 \ \mu A$	1 nA	$\pm 0.2\%$ of Value + 4 nA
$\pm 200 \ \mu A$	10 nA	$\pm 0.2\%$ of Value + 40 nA
$\pm 2 \text{ mA}$	100 nA	$\pm 0.2\%$ of Value + 400 nA
± 20 mA	1 μΑ	$\pm 0.3\%$ of Value + 4 μ A
± 150 mA	10 µA	\pm 0.4% of Value + 40 μA

FCB: HIGH-SPEED CLOCKS	WORKSTATION AND SOFTWARE
Eight fast clocks per FCB board	OS: Windows 7
with complementary outputs, up	Automation: ACT (Automation C Tools),
to 500MHz with programmable	TexTest for ASCII test control,
fractional ratio to the test rate	or HILEVEL AutoTest (GUI)
(from 1:1 up to 8:1, in 0.5 steps).	Controller: PC workstation, Windows 7,
One FCB per system maximum.	and HILEVEL Symphony III software
	Interface: USB 2





TEST RATE (AC pins)

Max Data & Compare Rate: 200 MHz Max Cycle Rate: 100 MHz, all modes (Two compares per cycle; two level transitions per cycle) 125 KHz/1 MHz Resolution: 0.1% of programmed value Accuracy: Minimum test rate: 125 KHz **AC TIMING** Timing Generators: 32, Globally Assigned Time Sets on the fly: 16 programmable timing/format sets on the fly (switched dynamically during test) 128 timing sets total Entire clock cycle + 10ns Range: Resolution: 50ps EPA (Edge Placement Accuracy): Standard Calibration: ±1.5ns Precision Calibration: ±500ps

PROGRAMMABLE PATTERN GENERATOR

Program Commands: Jump, Conditional Jump, Call, Conditional Call (four levels of Nesting), Return, Conditional Return, Loop (Repeat), Page (16 bit pages), Set Counter Value, Decrement Counter, Clear Fail Status, Trace mask On / Off, Pattern Match function.

DATA FORMATS

- R0 Return to zero
- R1 Return to one
- RI Return to inhibit
- RC Return to compliment (Surround by compliment)

AC PIN ELECTRONICS (32 channels per sint)

Logic Pins: DRIVERS All pins Input or Output or Bi-directional Min/Max Channels: 32/512 Increments of: 32 Pin To Pin Skew: +/- 500ps VIH: (VIL + 100 mV) to +6.5V VIL: -1.5V to (VIH – 100mV) Resolution: 5mV Rails: 1 pair per pin Accuracy: +/- 10mV Sink/Source Current: 50mA/50mA Slew Rate: 1.5V/ns Capacitance: (Lumped + Continuous) <50pF

Logic Pins: RECEIVERS/COMPARATORS

Range: -1.5V to +6.5 Resolution: 5mV Rails: 1 per pin/per threshold Accuracy: +/- 15mV

PE Memory:

Vector Depth: 64M per pin Acquisition Depth: 64M in Sequential mode 16M in Programmed mode *Scan (Optional)*: Scan depth: Up to 8Gbit Up to 128 scan chains Full scan capture capability up to 64M







Mixed Signal Option

The G3H system provides two slots for optional MX2 analog resource boards. The MX2 consist of a master board that accommodates up to four submodules. These submodules can be mixed or matched in any combination on the MX2 master board. The submodules currently available are described below.

16-Bit Fast AWG	24-Bit Precision AWG		
Resolution: 16-bit	Res	solution: 24-bit	
Update rate: 80MSPS	Upc	date rate: 196kSPS	
Pattern depth: 1M	Pattern depth: 1M		
Output ranges: 0.75V, 1.5V, 2V, 3V,	Out	put ranges: 0.75V, 1.5V, 2V,	
4V,6V,8V,12V	3V,4V,6V,8V,12V		
Output offset voltage: -3V to +3V	Output offset voltage: -3V to +3V		
Output filters: none, 10MHz, 25MHz	Output filters: none, 1.5kHz, 22kHz, 100kHz		
$DNL \le \pm 0.5 LSB @+25^{\circ} C$	$SNR/DNR \ge 120 \text{ dB}$		
$INL \le \pm 1.0 LSB (a) + 25^{\circ} C$	THD + N \leq -110 dB		
THD \leq -95 dB (a) fOUT = 1 MHz			
SFDR \geq 78 dBc @ fOUT = 20 MHz			
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16-Bit Digitizer		24-Bit Digitizer	
Resolution: 16-bit		Resolution: 24-bit	
Update rate: 80MSPS	Update rate: 2.5MSPS		
Pattern depth: 1M	Pattern depth: 1M		
Input ranges: 0.75V, 1.5V, 2V, 3V,	Input ranges: 0.75V, 1.5V, 2V,		
4V,6V,8V,12V	3V,4V,6V,8V,12V		
DC offset voltage: $-3V$ to $+3V$		DC offset voltage: -3V to +3V	
Input filters: none, 1MHz, 10MHz, 25MH	[z	Input filters: none, programmable from	
Input impedance: 1MOhm, or 600 Ohm		19.2kHz up to 1.35MHz, 16- steps	
$DNL \le \pm 0.5 LSB$ @ $\pm 25^{\circ} C$		Input impedance: 1MOhm, or 600 Ohm	
$INL \le \pm 3.0 LSB @+25^{\circ}C$		DNL – guaranteed monotonic to 24 bits	
$S/N \ge 77 \text{ dB}$ @ fOUT= 10MHz		$INL \le 0.00076 \% FS$	
$SINAD \ge 75 \ \overrightarrow{dB} \ \overrightarrow{a} \ fOUT = 10 \ MHz$		$S/N \ge 112 \text{ dB}$	
$SFDR \ge 80 \text{ dBc} (a) \text{ fOUT} = 10 \text{ Mhz}$		$THD \leq -105 \text{ dB}$	
<u> </u>		$SFDR \ge 120 \text{ dBc}$	





MAIN DUT POWER SUPPLIES	Optional Multiple DUT Supply Boards Four slots dedicated to accommodate up to
PS1	four DUT supply boards in any
Range: 0 to 8V, 0 to 2A	combination:
Resolution: 5mV, 10mA	MPS1
Accuracy: +/-15mV	One 0-3.7V/4A, One 0-8V/2A, Two
PS2 & PS3	±16V/1A
Range: +/-16V, 0 to 1A	MPS2
Resolution: 5mV, 10mA	Four 0-3.7V/4A
Accuracy: +/-15mV	All with Alternating Voltage Source (AVS)
PS4	
Range: 0 to 3.7V, 0 to 4A	Multi-Site Supplies
Resolution: 5mV, 10mA	One Supply per each 32 Pins (site)
Accuracy: +/-10mV	Voltage Range: 0-8V
	Resolution: 5mV
Current Measurement Resolution	Accuracy: 15mV
Range dependent.	Current Range: 0-1A
Best resolution is 1 nA.	Resolution: 10mA
	Accuracy: see table below

DUT SUPPLY MEASUREMENT RANGES

One Measurement Unit per system Voltage Measurement Range: -16V to +16V, Resolution: 5mV, Accuracy: $0.2\% \pm 2mV$

Current Ranges	Resolution	Accuracy
± 200 nA	10 pA	± 0.5% of Value + 100 pA
$\pm 2 \ \mu A$	100 pA	± 0.4% of Value + 500 pA
$\pm 20 \ \mu A$	1 nA	$\pm 0.2\%$ of Value + 4 nA
± 200 μA	10 nA	$\pm 0.2\%$ of Value + 40 nA
$\pm 2 \text{ mA}$	100 nA	$\pm 0.2\%$ of Value + 400 nA
± 20 mA	1 μΑ	$\pm 0.4\%$ of Value + 4 μ A
± 200 mA	10 μΑ	$\pm 0.4\%$ of Value + 40 μ A
± 2 A	100 μA	$\pm 0.5\%$ of Value + 400 μ A
± 5 A	250 μΑ	$\pm 0.5\%$ of Value + 1 mÅ

OTHER FEATURES

Real time Failure Counter Shows number of fails while running

Display Capture Fails Only Acquisition Memory Compression

High-speed Acquisition Search: Search 64M of capture in <3 sec.

Full "Next Cycle" Operation Data Valid for the full next cycle

ENVIRONMENTAL

Power 220VAC single phase, Max 20A Max Weight 85kg approx. (16 cards installed) Manipulator Adapter Option: 10kg Dimensions (Test head only) H508mm x W438mm x D438mm Cooling 9 fans Temperature 60 to 80 °F (16 to 27°C)





1-800-HILEVEL

